QPA9421 High Linearity 0.5 W Small Cell PA

Product Overview

The QPA9421 is a high-linearity two-stage power amplifier in a low-cost surface-mount package with on-chip bias control and temperature control circuits, suitable for small cell base station applications.

The QPA9421 provides 30 dB gain and +27 dBm linear power over the 2.11-2.17 GHz frequency range. This amplifier is able to achieve -50 dBc ACLR at +27 dBm output power using 20 MHz LTE signal.

The QPA9421 integrates two high performance amplifier stages onto a module to allow for a compact system design and requires very few external components for operation. The amplifier is bias adjustable allowing the amplifier's power consumption to be optimized. The QPA9421 is available in a 7×7 mm surface mount package.



7 mm x 7 mm Leadless SMT Package

Key Features

- 2.11-2.17 GHz Frequency Range
- Fully integrated, 2 Stage Power Amplifier
- Internally Matched 50 Ω Input/Output
- -50 dBc ACLR at Pavg = +27 dBm
- 30 dB Gain
- 14% PAE at +27 dBm
- 420 mA Quiescent Current
- On-chip Control Bias and Temp. Comp Circuit

GND Vref 1 14 GND GND 13 2 GND RF out 12 3 VCC1 VCC2 4 11 RF in GND 10 5 GND GND 6 9 Backside Paddle **RF/DC GND** NC GND 7 8 **Top View**

Applications

- Small Cell / Picocell
- Enterprise Femtocell
- Customer Premises Equipment (CPE)
- Data Cards and Terminals
- Distributed Antenna Systems (DAS)
- Booster Amps, Repeaters

Ordering Information

Part No.	Description
QPA9421TR13	2500 pieces on a 13" reel
QPA9421EVB-01	2.11 – 2.17 GHz Evaluation board

Functional Block Diagram

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Absolute Maximum Ratings

Parameter	Rating
Storage Temperature	−55 to +150 °C
Supply Voltage (Vcc)	+6 V
Vref	+3.5 V
RF Input Power, CW, 50Ω, T=25°C	+13 dBm
Tj at T _{CASE} = 125°C	+205°C

Operation of this device outside the parameter ranges given above may cause permanent damage.

Recommended Operating Conditions

Parameter	Min	Тур	Max	Units
V _{CC1} , V _{cc2}	+3.6	+4.5	+5.25	V
V _{ref}	+2.75	+2.85	+2.95	V
TCASE	-40		+85	°C
Tj at T _{CASE} max			+165	°C

Electrical specifications are measured at specified test conditions. Specifications are not guaranteed over all recommended operating conditions.

Electrical Specifications

Test conditions unless otherwise noted: $V_{CC1} = V_{CC2} = +4.5 \text{ V}$, Vref = +2.85 V, Temp= +25 °C

Parameter	Conditions	Min	Тур	Max	Units
Operational Frequency Range		2110		2170	MHz
Test Frequency			2140		MHz
Gain		27	29.6	33	dB
Input Return Loss	CW, Small Signal	15	21		dB
Output Return Loss		15	25		dB
P1dB	CW		+35.5		dBm
	Pout +27 dBm, 20 MHz LTE E-TM1.1, 9.5 dB PAR		-50	-47	dBc
	Pout +27 dBm, 20 MHz x 2 LTE E-TM1.1, 9.5dB PAR		-46		dBc
ACLR	POUT +27 dBm, 15 MHz LTE E-TM1.1, 9.5dB PAR		-50		dBc
	POUT +27 dBm, 10 MHz LTE E-TM1.1, 9.5dB PAR		-49		dBc
	POUT +27 dBm, 5 MHz LTE E-TM1.1, 9.5dB PAR		-49		dBc
Power Added Efficiency	P _{OUT} +27 dBm, 20 MHz LTE E-TM1.1, 9.5 dB PAR	13	14		%
Quiescent Current, Icq1	Vcc1 + Vcc2	330	420	510	mA
Leakage Current on Vcc	Vcc +4.5V, V _{ref} 0V		3	10	μA
Reference Current , I_{ref}	Temp -40°C to +85°C, V _{ref} = +2.85V		13	19.5	mA
Operational Current, I _{CC}	P _{OUT} +27 dBm, 20 MHz LTE E-TM1.1, 9.5 dB PAR		680	920	mA
Wake Up Time	50% of control signal to 90% of the RF output		715		ns
Power Down Time	50% of control signal to 10% of the RF output		1370		ns
Spurious Output Level	$P_{OUT} \le +27$ dBm, In & Out of band load VSWR $\le 10:1$		-60		dBc
VSWR survivability	No permanent degradation or failure	10:1			-
	2F ₀ (Pout +27 dBm), CW signal		-39	-33	dBc
Harmonics	3F₀ (Pout +27 dBm), CW signal		-48	-37	dBc
	4F ₀ (P _{OUT} +27 dBm), CW signal		-64	-37	dBc
Thermal Resistance, θ _{jc}	Module (junction to case)			18.5	°C/W

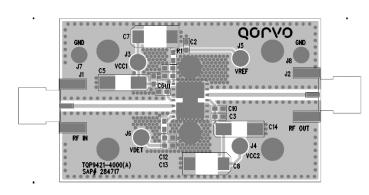
Notes:

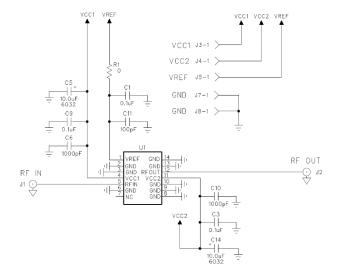
1. Vcc1 draws very little current and provides the bias voltage to the current mirror circuit along with Vref to set the bias point for the whole amplifier.

2. Control signal applied to Vref Pin, 0 to 2.85V

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QPA9421 Application Circuit Schematic and Layout





Bill of Material - QPA9421EVB-01

Ref Designation Value D		Description	Manufacture	Part Number
-	-	Printed Circuit Board	Qorvo	
U1	-	Amplifier, High Linearity 0.5 W Power Qorvo 0		QPA9421
R1	0 Ω	Resistor, Chip, 0603, 5%	various	
C1	0.01 µF	Capacitor, Chip, 0603, 5%	various	
C11	100 pF	Capacitor, Chip, 0603, 5%	various	
C3, C9	0.1 µF	Capacitor, Chip, 0603, 5%	various	
C5, C14	10 µF	Capacitor, Chip, 6032, 10%, Tantalum	various	
C6, C10	1000 pF	Capacitor, Chip, 0603, 5%, NPO/C0G	various	

QPA9421EVB-01 Typical Performances

Test conditions unless otherwise noted: V _{CC1} = V _{CC2} = +4.5 V, Vref = +2.85 V, Pout 27dBm, 2140MHz, Signal PAR 9.5dB, Temp= +25 °C							
LTE Signal BW	5MHz	10MHz	15MHz	20MHz	20MHz x 2	Units	
ACLR1-Low	-49.9	-49.3	-50.2	-50.0	-46.5	dBc	
ACLR1-high	-49.9	-50.3	-50.5	-50.7	-48.1	dBc	

Parameter	Conditions	-40°C	+25°C	+85°C	Units
Gain		30.9	29.0	27.6	dB
ACLR	Pout = +27 dBm, 20 MHz LTE E-TM1.1, 9.5dB PAR	-50.3	-50.0	-49.2	dBc
PAE		14.5	14.1	13.3	%
P1dB	CW	+35.8	+35.5	+34.3	dBm

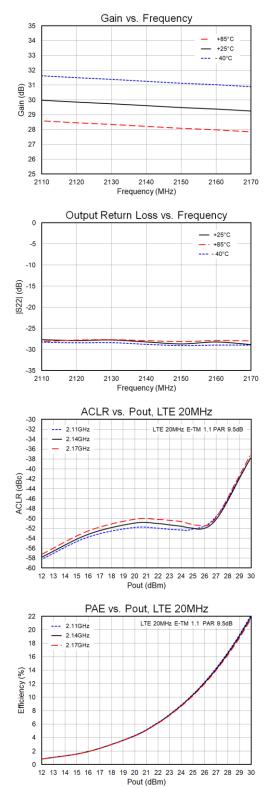
Test Frequency = 2140MHz

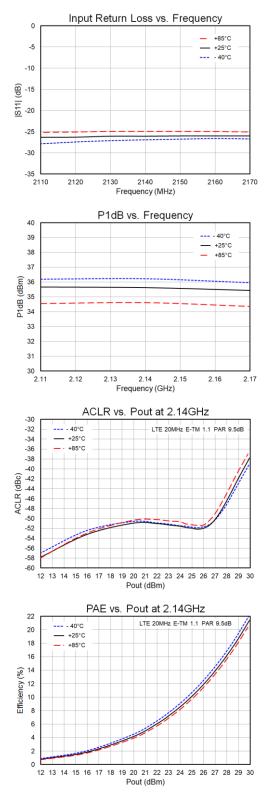


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Performance Plots

Test conditions unless otherwise noted: V_{CC1} = V_{CC2} = +4.5V, Vref = +2.85 V, LTE signal PAR = 9.5dB, Temp.= +25 °C

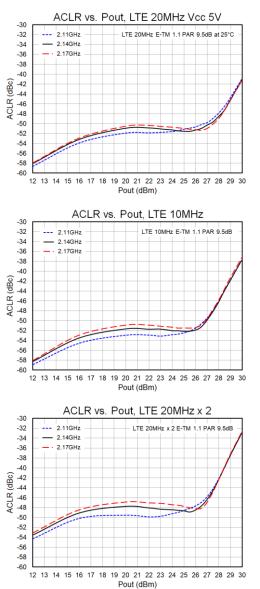


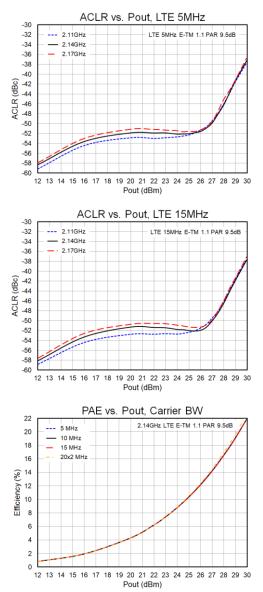


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Performance Plots (continue)

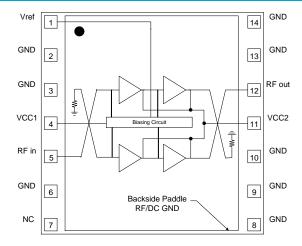
Test conditions unless otherwise noted: V_{CC1} = V_{CC2} = +4.5V, Vref = +2.85V, LTE signal PAR = 9.5dB, Temp.= +25 °C





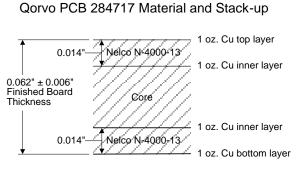
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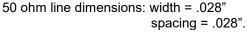
Pin Configuration and Description

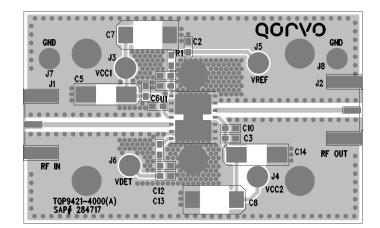


Pin No.	Label	Description
1	Vref	Provides reference voltage for internal active biasing circuit
2, 3, 6, 8, 9, 10, 13, 14	GND	RF and DC ground.
4	VCC1	Bias voltage for current mirror in combination with Vref to set the bias point.
5	RFin	RF input pin. The DC is internally blocked at this pin.
7	NC	No internal connection. Can be left open or grounded for mounting integrity.
11	VCC2	Supply to all stages.
12	RFout	RF output pin. The DC is internally blocked at this pin.
Backside Paddle	RF/DC GND	RF/DC ground. See PCB Mounting Pattern for suggested footprint.

Evaluation Board PCB Information





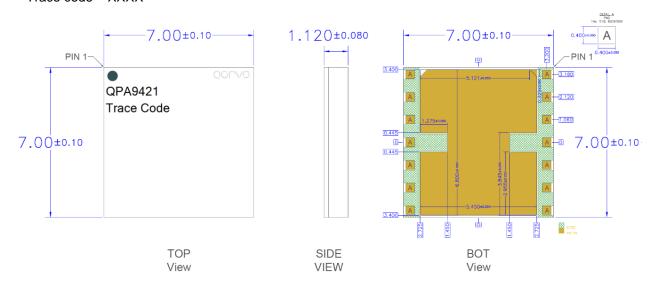


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Mechanical Information

Package Marking and Dimensions

Marking: Part number – QPA9421 Trace code – XXXX

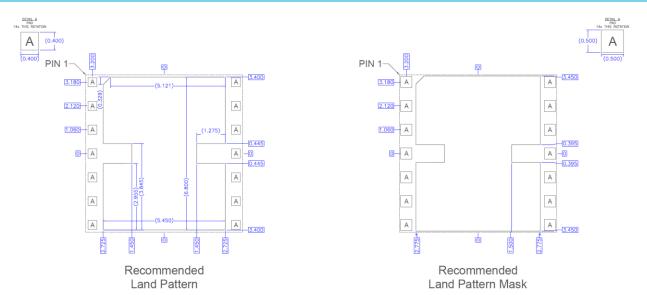


Notes:

- 1. All dimensions are in millimeters. Angles are in degrees.
- 2. Dimension and tolerance formats conform to ASME Y14.4M-1994.

3. The terminal #1 identifier and terminal numbering conform to JESD 95-1 SPP-012.

PCB Mounting Pattern

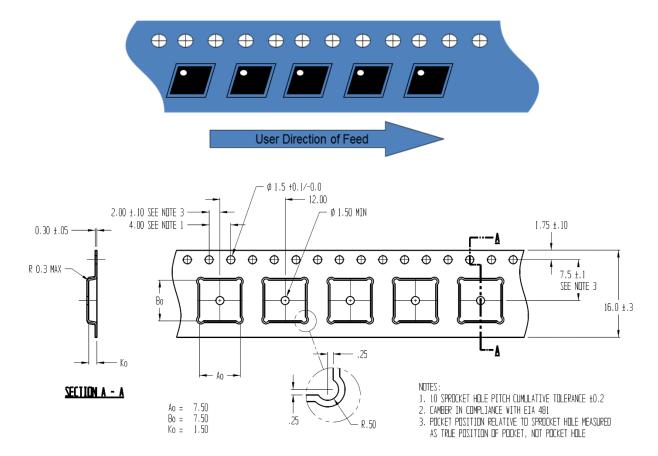


Notes:

- 1. A heat sink underneath the area of the PCB for the mounted device is strictly required for proper thermal operation. Damage to the device can occur without the use of one.
- 2. Ground / thermal via holes are critical for the proper performance of this device. Via holes should use a .35mm (#80 / .0135") diameter drill and have a final plated thru diameter of .25 mm (.010").
- 3. Add as much copper as possible to inner and outer layers near the part to ensure optimal thermal performance.

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Tape and Reel Information – Carrier and Cover Tape Dimensions

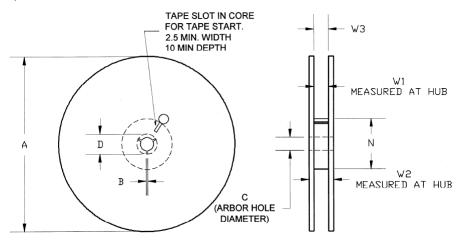


Feature	Measure	Symbol	Size (in)	Size (mm)
	Length	A0	0.295	7.50
Covity	Width	B0	0.295	7.50
Cavity	Depth	K0	0.059	1.50
	Pitch	P1	0.472	12.0
Cantarlina Distance	Cavity to Perforation - Length Direction	P2	0.079	2.00
Centerline Distance	Cavity to Perforation - Width Direction	F	0.295	7.50
Cover Tape	Width	С	0.524	13.3
Carrier Tape	Width	W	0.630	16.0

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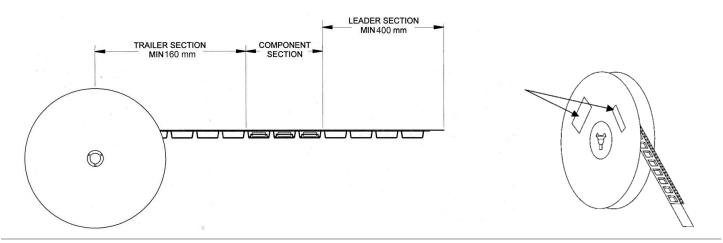
Tape and Reel Information – Reel Dimensions (13")

Standard T/R size = 2,500 pieces on a 13" reel.



Feature	Measure	Symbol	Size (in)	Size (mm)
	Diameter	A	12.992	330.0
Flange	Thickness	W2	0.874	22.2
	Space Between Flange	W1	0.661	16.8
	Outer Diameter	N	4.016	102.0
Hub	Arbor Hole Diameter	С	0.512	13.0
Hub	Key Slit Width	В	0.079	2.0
	Key Slit Diameter	D	0.787	20.0

Tape and Reel Information – Tape Length and Label Placement



Notes:

1. Empty part cavities at the trailing and leading ends are sealed with cover tape. See EIA 481-1-A.

2. Labels are placed on the flange opposite the sprockets in the carrier tape.



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Handling Precautions

Parameter	Rating	Standard		
ESD-Human Body Model (HBM)	Class 1A	ESDA/JEDEC JS-001-2012		Caution!
ESD-Charged Device Model (CDM)	Class C3	JEDEC JESD22-C101F	A B	ESD-Sensitive Device
MSL-Moisture Sensitivity Level	Level 3	IPC/JEDEC J-STD-020		

Solderability

Compatible with both lead-free (260°C max. reflow temp.) and tin/lead (245°C max. reflow temp.) soldering processes. Solder profiles available upon request.

Contact plating: Electrolytic plated Au over Ni (Plating thickness: Ni 5.0±30µm, Au 0.10µm minimum)

RoHS Compliance

This part is compliant with the 2011/65/EU RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment) as amended by Directive 2015/863/EU. This product also has the following attributes:

- Product uses RoHS Exemption 7c-I to meet RoHS Compliance requirements.
- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A (C₁₅H₁₂Br₄0₂) Free
- PFOS Free
- SVHC Free

Contact Information

For the latest specifications, additional product information, worldwide sales and distribution locations:

Web: <u>www.qorvo.com</u>

Tel: 1-844-890-8163

Email: <u>customer.support@gorvo.com</u>

For technical questions and application information:

Email: appsupport@gorvo.com

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